
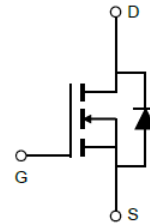
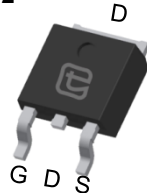


**40V N-Channel Trench MOSFET(Preliminary)**

<p><b>General Description</b></p> <ul style="list-style-type: none"> <li>● Trench Power technology</li> <li>● Low <math>R_{DS(ON)}</math></li> <li>● Low Gate Charge</li> <li>● Optimized for fast-switching applications</li> </ul> <p><b>Applications</b></p> <ul style="list-style-type: none"> <li>● Synchronous Rectification in DC/DC and AC/DC Converters</li> <li>● Isolated DC/DC Converters in Telecom and Industrial</li> </ul>	<p><b>Product Summary</b></p> <table> <tr> <td><math>V_{DS}</math></td> <td>40V</td> </tr> <tr> <td><math>I_D</math> (at <math>V_{GS}=10V</math>)</td> <td>20A</td> </tr> <tr> <td><math>R_{DS(ON)}</math> (at <math>V_{GS}=10V</math>)</td> <td>&lt;23m<math>\Omega</math></td> </tr> <tr> <td><math>R_{DS(ON)}</math> (at <math>V_{GS}=4.5V</math>)</td> <td>&lt;28m<math>\Omega</math></td> </tr> </table> <p>100% UIS Tested</p> 	$V_{DS}$	40V	$I_D$ (at $V_{GS}=10V$ )	20A	$R_{DS(ON)}$ (at $V_{GS}=10V$ )	<23m $\Omega$	$R_{DS(ON)}$ (at $V_{GS}=4.5V$ )	<28m $\Omega$
$V_{DS}$	40V								
$I_D$ (at $V_{GS}=10V$ )	20A								
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	<23m $\Omega$								
$R_{DS(ON)}$ (at $V_{GS}=4.5V$ )	<28m $\Omega$								

TO-252



Part Number	Package Type	Form	Marking
TTD20N04AT	TO-252	Tape&Reel	TTD20N04AT

**Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>B</sup>	$I_D$	$T_C = 25^\circ\text{C}$	20
		$T_C = 100^\circ\text{C}$	17
Pulsed Drain Current <sup>A</sup>	$I_{DM}$	60	A
Avalanche Current <sup>A</sup>	$I_{AS}$	13	A
Single Pulse Avalanche Energy $L = 0.3\text{mH}$ <sup>A</sup>	$E_{AS}$	25	mJ
Power Dissipation <sup>C</sup>	$P_D$	$T_C = 25^\circ\text{C}$	28.8
		$T_C = 100^\circ\text{C}$	14.4
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	$^\circ\text{C}$

**Thermal Characteristics**

Parameter	Symbol	Maximum	Units
Maximum Junction-to-Case	$R_{\theta JC}$	5.2	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Ambient	$R_{\theta JA}$	100	



Electrical Characteristics( $T_J = 25^\circ\text{C}$ unless otherwise noted)						
Symbol	Parameter	Conditions	Value			Units
			Min	Typ	Max	
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}$	$T_J = 25^\circ\text{C}$		1	$\mu\text{A}$
			$T_J = 125^\circ\text{C}$		100	
$I_{GSS}$	Gate-Body Leakage Current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.4	2	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 20\text{A}$		18	23	$\text{m}\Omega$
		$V_{GS} = 4.5\text{V}, I_D = 16\text{A}$		21.5	28	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 5\text{V}, I_D = 20\text{A}$		19		S
$V_{SD}$	Diode Forward Voltage	$I_S = 20\text{A}, V_{GS} = 0\text{V}$			1	V
$I_S$	Maximum Body-Diode Continuous Current <sup>B</sup>				20	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}, V_{DS} = 20\text{V}, f = 1\text{MHz}$		659		$\text{pF}$
$C_{oss}$	Output Capacitance			70		
$C_{rss}$	Reverse Transfer Capacitance			62		
$R_g$	Gate Resistance	$f = 1\text{MHz}$		1.2		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS} = 10\text{V}, V_{DS} = 20\text{V}, I_D = 20\text{A}$		16.7		nC
$Q_g(4.5\text{V})$	Total Gate Charge			9		
$Q_{gs}$	Gate Source Charge			1.9		
$Q_{gd}$	Gate Drain Charge			4.5		
$t_{D(on)}$	Turn-On Delay Time	$V_{GS} = 10\text{V}, V_{DS} = 20\text{V}, I_D = 20\text{A}, R_G = 1.8\Omega$		31		ns
$t_r$	Turn-On Rise Time			3.6		
$T_{D(off)}$	Turn-Off Delay Time			46		
$t_f$	Turn-Off Fall Time			2.8		
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F = 20\text{A}, di/dt = 100\text{A}/\mu\text{s}$		18.3		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge			4		nC

A. Single pulse width limited by maximum junction temperature.

B. The maximum current rating is package limited.

C. The power dissipation  $P_D$  is based on  $T_{J(MAX)} = 175^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.



### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

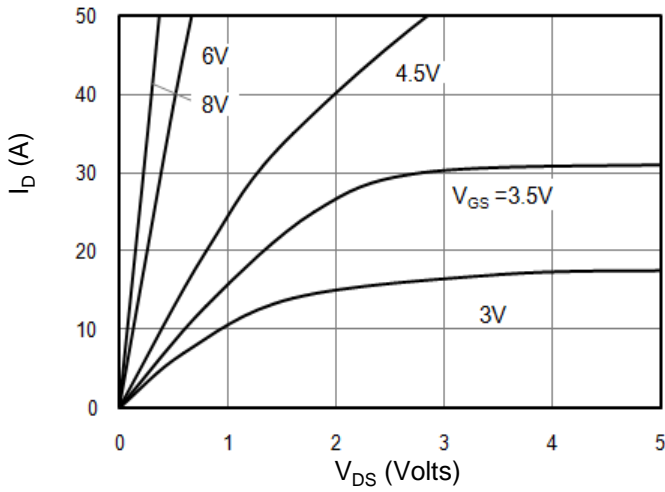


Figure 1: On-Region Characteristics

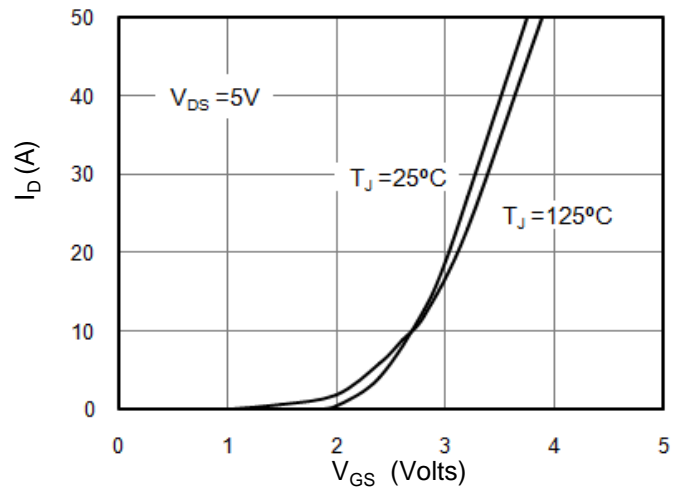


Figure 2: Transfer Characteristics

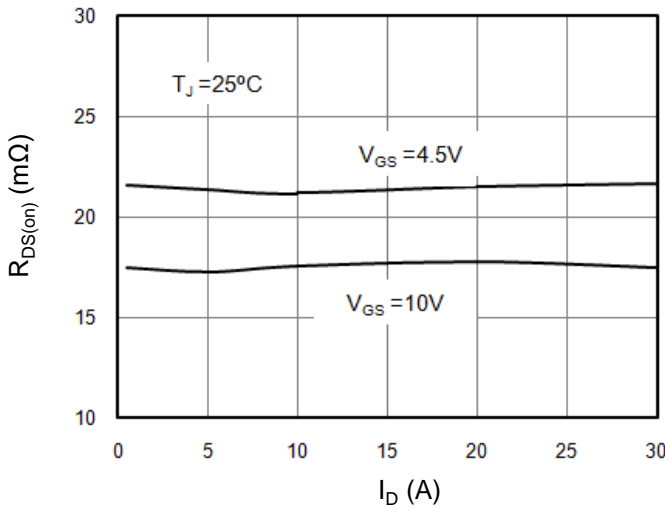


Figure 3: On-Resistance vs. Drain Current

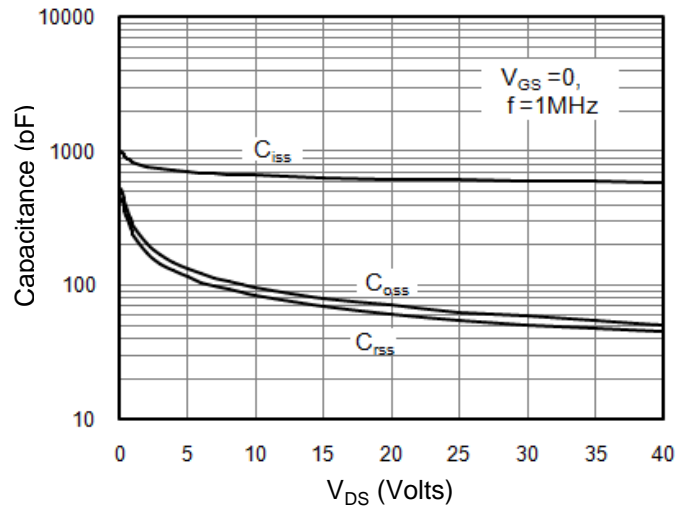


Figure 4: Capacitance Characteristics

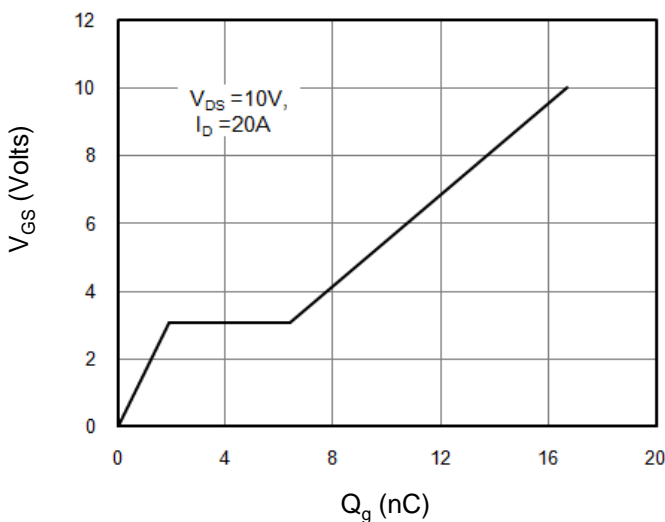


Figure 5: Gate Charge Characteristics

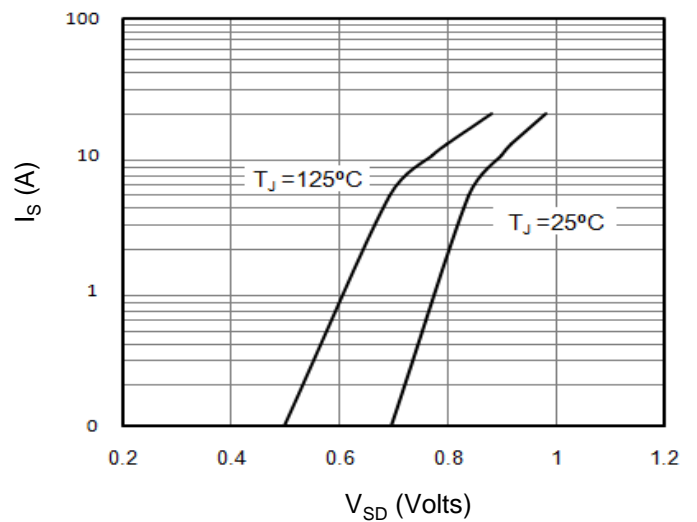


Figure 6: Body Diode Forward Voltage



### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

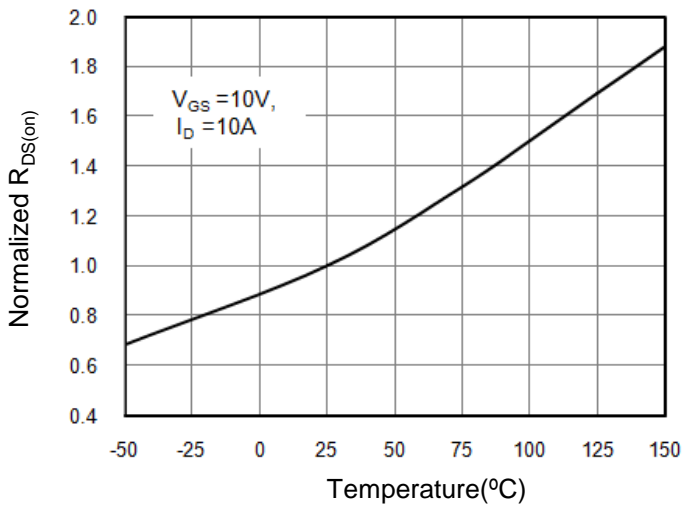


Figure 7: On-Resistance vs. Junction Temperature

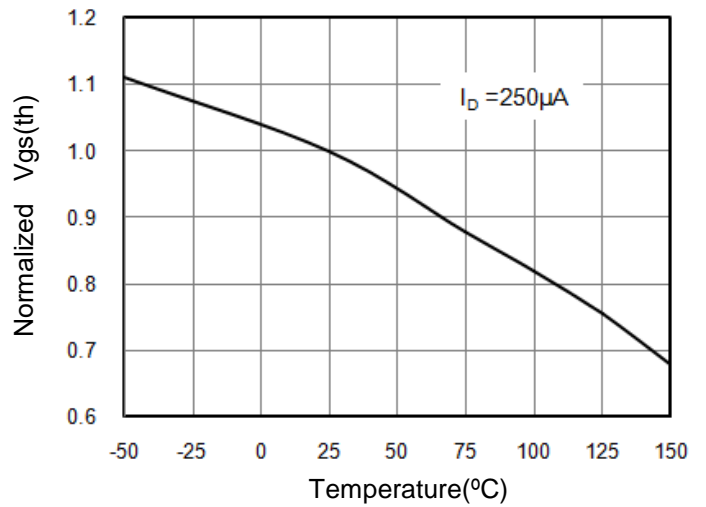


Figure 8:  $V_{GS(th)}$  vs. Junction Temperature

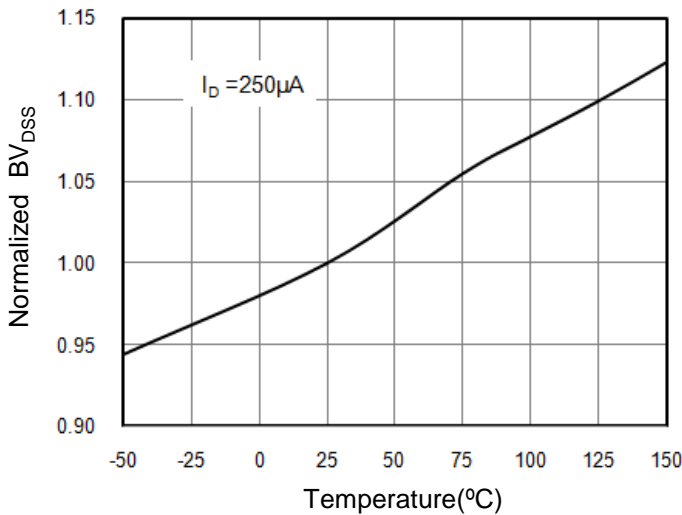


Figure 9:  $BV_{DS}$  vs. Junction Temperature

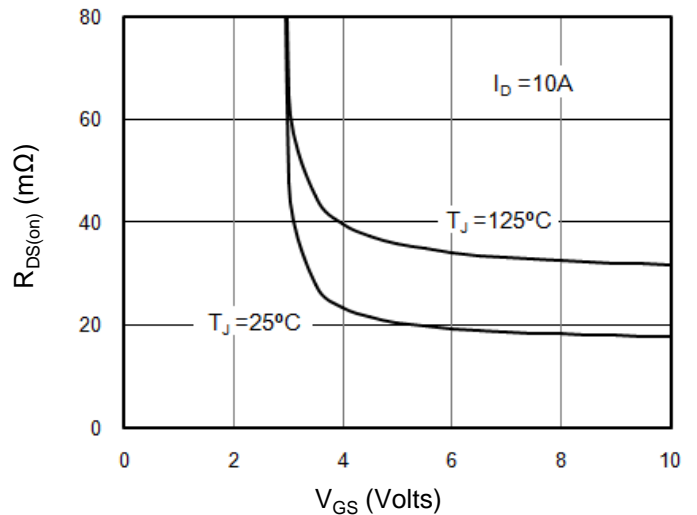


Figure 10: On-Resistance vs. Gate-Source Voltage

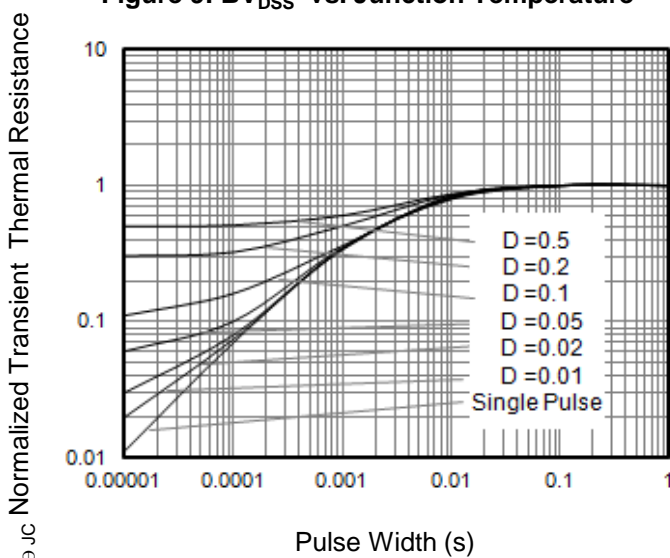


Figure 11: Normalized Transient Thermal Resistance

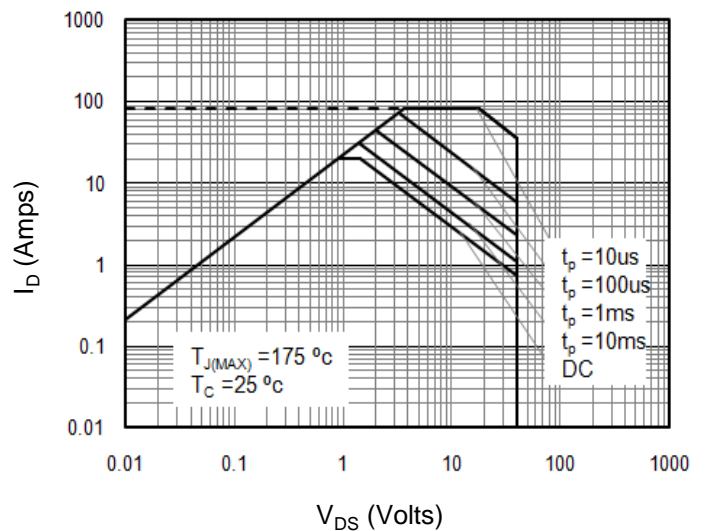


Figure 12: Safe Operating Area



Figure A: Gate Charge Test Circuit and Waveforms

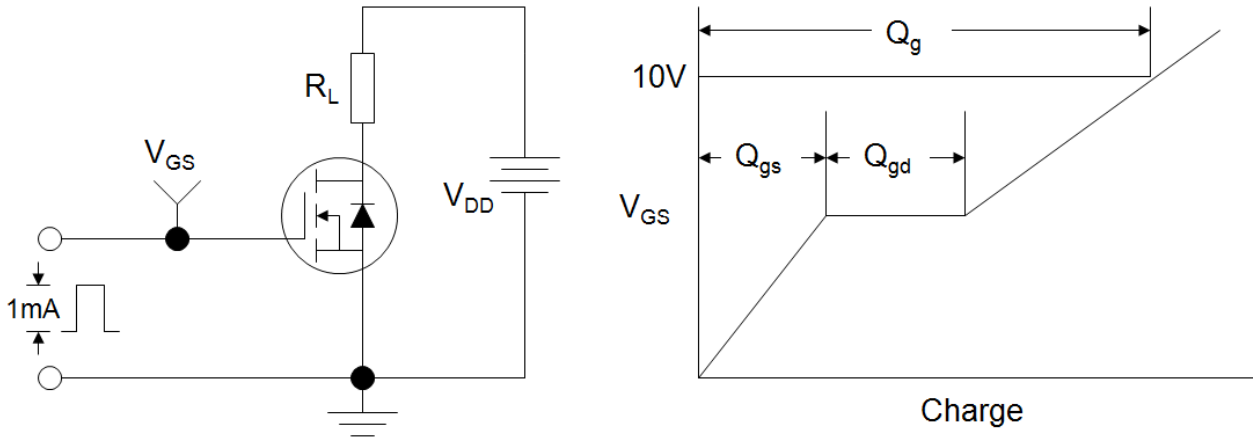


Figure B: Resistive Switching Test Circuit and Waveforms

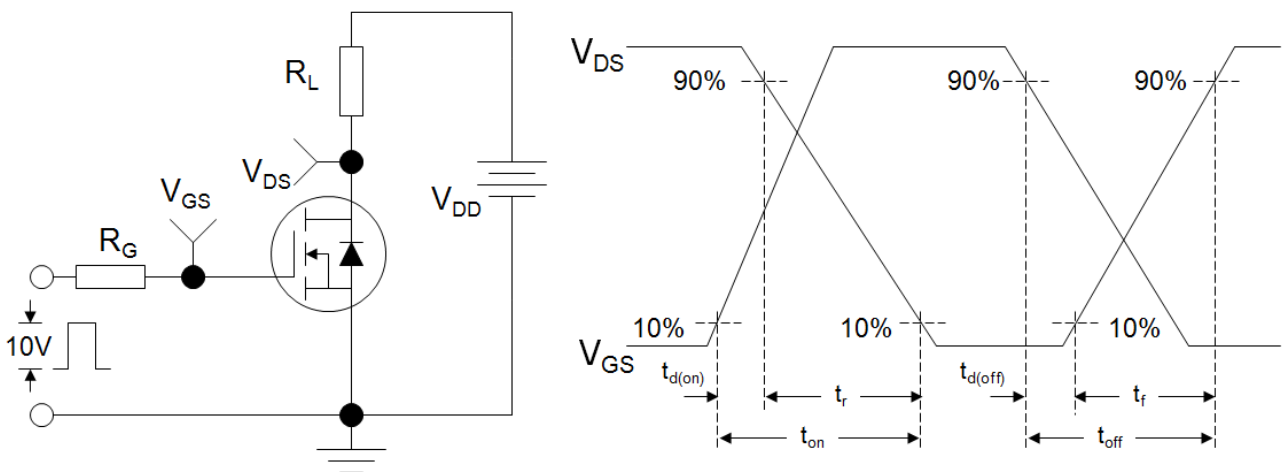
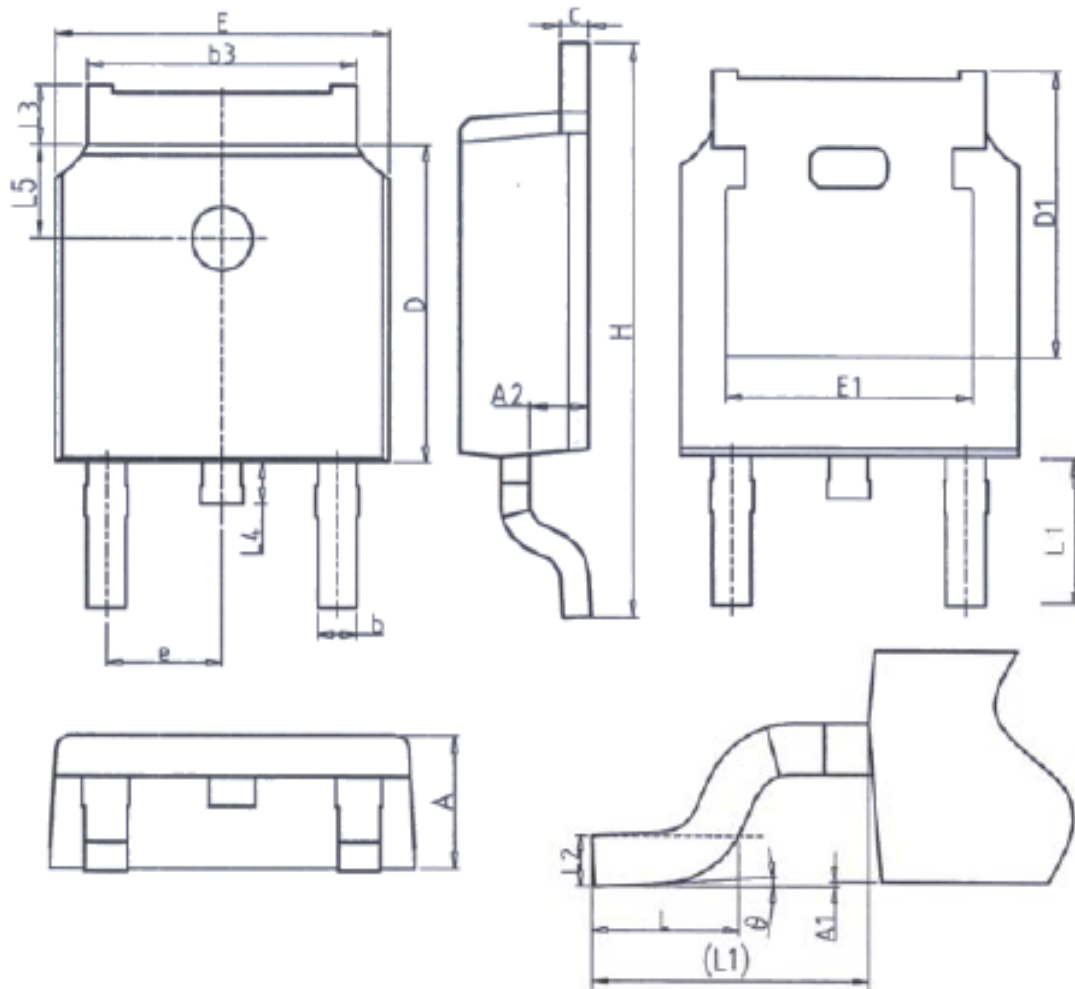


Figure C: Unclamped Inductive Switching (UIS) Test Circuit and Waveforms





## TO-252(集佳)



Unit: mm			
Symbol	Min	Nom	Max
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.90	1.01	1.10
b	0.72	-	0.85
b3	5.13	5.33	5.46
c	0.47	-	0.60
D	6.00	6.10	6.20
D1	5.25 REF		
E	6.50	6.60	6.70
E1	4.70	-	-

Unit: mm			
Symbol	Min	Nom	Max
e	2.286BSC		
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.508BSC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	1.8 REF		
$\theta$	0°	-	8°



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